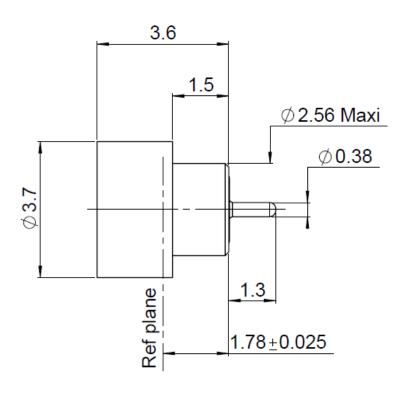




HERMETIC STRAIGHT MALE RECEPTACLE SOLDER TYPE - LIMITED DETENT

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All dimensions are in mm.



COMPONENTS	MATERIALS	PLATING (μm)
Body Center contact	DILVER P1 DILVER P1	GOLD OVER NICKEL GOLD OVER NICKEL
Outer contact Insulator	GLASS	
Gasket		
Others parts		
-	-	-
-	-	-



Technical Data Sheet

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PACKAGING

Standard	Unit	Other
100	Contact us	Contact us

ELECTRICAL CHARACTERISTICS

 VSWR
 *1.15
 +
 0.0000
 x F(GHz) Maxi

 Insertion loss
 0.12
 √F(GHz) dB Maxi

 RF leakage
 - (
 - F(GHz)) dB Maxi

 Voltage rating
 335
 Veff Maxi

 Veff Maxi
 Veff Maxi

 $\begin{array}{ccc} \mbox{Voltage rating} & \mbox{333} & \mbox{Veff Max} \\ \mbox{Dielectric withstanding voltage} & \mbox{500} & \mbox{Veff mini} \\ \mbox{Insulation resistance} & \mbox{5000} & \mbox{M}\Omega \mbox{ mini} \\ \end{array}$

MECHANICAL CHARACTERISTICS

Center contact retention

Axial force – Mating End
Axial force – Opposite end
Torque

6.8 N mini
6.8 N mini
N mini
N mini
N.cm mini

Recommended torque

Mating NA N.cm Panel nut NA N.cm

Mating life 500 Cycles mini Weight 0.0990 g

ENVIRONMENTAL

Operating temperature -65/+165 °C
Hermetic seal 10-8 Atm.cm3/s
Panel leakage NA

SPECIFICATION

OTHER CHARACTERISTICS

Assembly instruction:

Others:

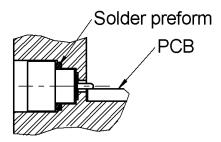
* to 18GHz





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- 1. Degrease and clean connector and box
- 2. Solder the connector on the panel we advise SnAg4 Cu0.5, we recommand a low residue flux. Preheating at 100 °C. Take care not to exceed 260°C during solder operation
- 3. Solder the pin on the track we advise SnAg4 Cu0.5, we recommand a low residue flux. Preheating at 100 °C (only for ceramic substrate). Take care not to exceed 260°C during solder operation

